

Specification for Shrink film

Product Description – Shrink Anti-Static

Product: Shrink Anti-static+ Thermal Stability Film

Catalog Number:5021

Product Description: Anti-static shrink films with thermal stability are flexible packaging materials designed to prevent static buildup while maintaining consistent shrink performance under elevated temperatures. The films provide protection against dust and electrostatic discharge, along with stable mechanical and shrink properties during heat exposure. Used for electronics, industrial products, and high-temperature packaging applications, ensuring product protection, cleanliness, and process stability

Thickness: 35-90μ

Width: Can change accordingly per customer request

Shrink hood film specification:

- Mechanical and physical properties:

Property	Units	Value		Test Method
		Min	Max	
Coefficient of Friction – static and dynamic inside/inside layer	-	0.3	0.4	ISO 8195 or ASTM -D1894
Shrink % (MD\TD) - 140°C	-	70/10	80/30	Internal
Anti-Static	V	10	12	Internal